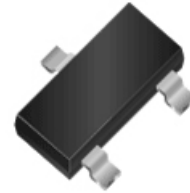


WNM2027

N-Channel, 20V, 3.6A, Power MOSFET

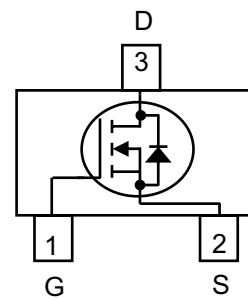
$V_{(BR)DSS}$	Rds(on) (Max. mΩ)	Id (A)
20	45 @ 4.5V	3.6
	55 @ 2.5V	3.1
	66 @ 1.8V	1.5



SOT-23

Descriptions

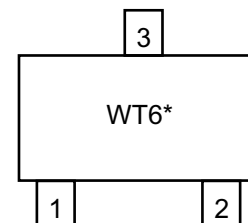
The WNM2027 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in DC-DC conversion and power switch applications. Standard Product WNM2027 is Pb-free.



Configuration (Top View)

Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23



WT6 = Device Code
* = Month (A~Z)

Marking

Applications

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch

Order Information

Device	Package	Shipping
WNM2027-3/TR	SOT-23	3000/Tape&Reel

WNM2027

ABSOLUTE MAXIMUM RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted					
Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	± 8		
Continuous Drain Current ($T_J = 150\text{ }^\circ\text{C}$) ^a	$T_A = 25\text{ }^\circ\text{C}$	I_D	3.2	2.9	A
	$T_A = 70\text{ }^\circ\text{C}$		2.5	2.3	
Maximum Power Dissipation ^a	$T_A = 25\text{ }^\circ\text{C}$	P_D	0.8	0.7	W
	$T_A = 70\text{ }^\circ\text{C}$		0.5	0.4	
Continuous Drain Current ($T_J = 150\text{ }^\circ\text{C}$) ^b	$T_A = 25\text{ }^\circ\text{C}$	I_D	2.9	2.7	A
	$T_A = 70\text{ }^\circ\text{C}$		2.3	2.1	
Maximum Power Dissipation ^b	$T_A = 25\text{ }^\circ\text{C}$	P_D	0.6	0.5	W
	$T_A = 70\text{ }^\circ\text{C}$		0.4	0.3	
Pulsed Drain Current ^c		I_{DM}	10		A
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	$t \leq 10\text{ s}$	$R_{\theta JA}$	125	150	$^\circ\text{C/W}$
	Steady State		140	175	
Junction-to-Ambient Thermal Resistance ^b	$t \leq 10\text{ s}$	$R_{\theta JA}$	150	180	
	Steady State		165	210	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	60	76	

- a Surface mounted on FR4 Board using 1 in sq pad size, 1oz Cu.
- b Surface mounted on FR4 board using the minimum recommended pad size, 1oz Cu.
- c Repetitive rating, pulse width limited by junction temperature, $t_p = 10\mu\text{s}$, Duty Cycle=1%
- d Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150\text{ }^\circ\text{C}$.

WNM2027
Electronics Characteristics

(Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16\text{ V}, V_{GS} = 0\text{ V}$			0.5	μA
Gate-to-source Leakage Current	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8.0\text{ V}$			± 100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	0.4	0.6	1	V
Drain-to-source On-resistance	$R_{DS(on)}$	$V_{GS} = 4.5\text{ V}, I_D = 3.6\text{ A}$		40	45	m Ω
		$V_{GS} = 2.5\text{ V}, I_D = 3.1\text{ A}$		47	55	
		$V_{GS} = 1.8\text{ V}, I_D = 1.5\text{ A}$		55	66	
		$V_{GS} = 1.5\text{ V}, I_D = 1.0\text{ A}$		65	75	
Forward Transconductance	g_{FS}	$V_{DS} = 5\text{ V}, I_D = 3.1\text{ A}$		11		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C_{ISS}	$V_{GS} = 0\text{ V}, f = 1.0\text{ MHz},$ $V_{DS} = 10\text{ V}$		500	700	pF
Output Capacitance	C_{OSS}			68	150	
Reverse Transfer Capacitance	C_{RSS}			60	90	
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V},$ $I_D = 2.7\text{ A}$		6.5		nC
Threshold Gate Charge	$Q_{G(TH)}$			0.6		
Gate-to-Source Charge	Q_{GS}			0.8		
Gate-to-Drain Charge	Q_{GD}			1.5		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_d(ON)$	$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V},$ $R_L = 3\ \Omega, R_G = 6\ \Omega$		5	8	ns
Rise Time	t_r			6	9	
Turn-Off Delay Time	$t_d(OFF)$			30	45	
Fall Time	t_f			8	12	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Forward Recovery Voltage	V_{SD}	$V_{GS} = 0\text{ V}, I_S = 1.0\text{ A}$	0.5	0.62	0.9	V